MAX1854xEEE Rev. A

RELIABILITY REPORT

FOR

MAX1864TEEE

PLASTIC ENCAPSULATED DEVICES

December 7,2001

MAXIM INTEGRATED PRODUCTS

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Conclusion

The MAX1864T successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

Table of Contents

I.Device Description II.Manufacturing Information III.Packaging Information IV.Die Information V.Quality Assurance Information VI.Reliability Evaluation

.....Attachments

I. Device Description

A. General

The MAX1864T power-supply controllers are designed to address cost-conscious applications such as cable modem Consumer Premise Equipment (CPE), xDSL CPE, and set-top boxes. Operating off a low-cost, unregulated DC supply (such as a wall adapter output), the MAX1864T generates three positive outputs to provide a cost-effective system power supply.

The MAX1864T includes a current-mode synchronous step-down controller and two positive regulator gain blocks. The main synchronous step-down controller generates a high-current output that is preset to 3.3V or adjustable from 1.236V to 0.8 x V_{IN} with an external resistive-divider. The 100kHz/200kHz operating frequency allows the use of low-cost aluminum-electrolytic capacitors and low-cost power magnetics. Additionally, the MAX1864T step-down controllers sense the voltage across the low-side MOSFET's on-resistance to efficiently provide the current-limit signal, eliminating the need for costly current-sense resistors.

The MAX1864T generate additional supply rails at low cost. The positive regulator gain blocks use an external PNP pass transistor to generate low-voltage rails directly from the main step-down converter (such as 2.5V or 1.8V from the main 3.3V output) or higher voltages using coupled windings from the step-down converter (such as 5V, 12V, or 15V).

All output voltages are externally adjustable, providing maximum flexibility. Additionally, the MAX1864T feature softstart for the step-down converter and all the positive linear regulators, and have a power-good output that monitors all of the output voltages.

B. Absolute Maximum Ratings

Rating
-0.3V to +30V
-20V to +0.3V
-0.3V to +6V
-6V to +0.3V
-0.3V to +36V
-0.3V to (VBst +0.3V)
-0.3V to (VL +0.3V)
50mA
-0.3V to (V _{IN} 0.3V)
-40°C to +85°C
-65°C to +150°C
+150°C
+300°C
666W
8.3mW/°C

II. Manufacturing Information

A. Description/Function:	xDSL/Cable Modem Triple Output Power Supplies
B. Process:	S8 - Standard .8 micron silicon gate CMOS
C. Number of Device Transistors:	1617
D. Fabrication Location:	California, USA
E. Assembly Location:	Philippines, Malaysia, Thailand or Korea
F. Date of Initial Production:	April, 2001

III. Packaging Information

A. Package Type:	16-Lead QSOP
B. Lead Frame:	Copper
C. Lead Finish:	Solder Plate
D. Die Attach:	Silver-filled epoxy
E. Bondwire:	Gold (1.2 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	Buildsheet # 05-2301-0096
H. Flammability Rating:	Class UL94-V0
I. Classification of Moisture Sensitivity p	er JEDEC standard JESD22-A112: Level 1

IV. Die Information

A. Dimensions:	70 x 92 mils
B. Passivation:	Si_3N_4/SiO_2 (Silicon nitride/ Silicon dioxide)
C. Interconnect:	TiW/ AICu/ TiWN
D. Backside Metallization:	None
E. Minimum Metal Width:	.8 microns (as drawn)
F. Minimum Metal Spacing:	.8 microns (as drawn)
G. Bondpad Dimensions:	5 mil. Sq.
H. Isolation Dielectric:	SiO ₂
I. Die Separation Method:	Wafer Saw

V. Quality Assurance Information

Α.	Quality Assurance Contacts:	Jim Pedicord	(Reliability Lab Manager)
		Bryan Preeshl	(Executive Director of QA)
		Kenneth Huenin	g (Vice President)

- B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.
 0.1% For all Visual Defects.
- C. Observed Outgoing Defect Rate: < 50 ppm
- D. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in **Table 1**. Using these results, the Failure Rate (λ) is calculated as follows:

 $\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{1.83}_{192 \text{ x } 4389 \text{ x } 158 \text{ x } 2} \text{ (Chi square value for MTTF upper limit)}$ $\longrightarrow \text{ Thermal acceleration factor assuming a } 0.8 \text{eV} \text{ activation energy}$ $\lambda = 6.87 \text{ x } 10^{-9} \qquad \lambda = 6.87 \text{ F.I.T.} \text{ (60\% confidence level @ 25°C)}$

This low failure rate represents data collected from Maxim's reliability qualification and monitor programs. Maxim also performs weekly Burn-In on samples from production to assure the reliability of its processes. The reliability required for lots which receive a burn-in qualification is 59 F.I.T. at a 60% confidence level, which equates to 3 failures in an 80 piece sample. Maxim performs failure analysis on lots exceeding this level. The following Burn-In Schematic (Spec. # 06-5707) shows the static circuit used for this test. Maxim also performs 1000 hour life test monitors quarterly for each process. This data is published in the Product Reliability Report (**RR-1L**).

B. Moisture Resistance Tests

Maxim evaluates pressure pot stress from every assembly process during qualification of each new design. Pressure Pot testing must pass a 20% LTPD for acceptance. Additionally, industry standard 85°C/85%RH or HAST tests are performed quarterly per device/package family.

C. E.S.D. and Latch-Up Testing

The PY71 die type has been found to have all pins able to withstand a transient pulse of $\pm 1000V$, per Mil-Std-883 Method 3015 (reference attached ESD Test Circuit). Latch-Up testing has shown that this device withstands a current of ± 200 mA.

Table 1Reliability Evaluation Test Results

MAX1864TEEE

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES
Static Life Test	t (Note 1)			
	Ta = 135°C Biased Time = 192 hrs.	DC Parameters & functionality	158	0
Moisture Testi	ng (Note 2)			
Pressure Pot	Ta = 121°C P = 15 psi. RH= 100% Time = 168hrs.	DC Parameters & functionality (generic test vehicle)	200	0
85/85	Ta = 85°C RH = 85% Biased Time = 1000hrs.	DC Parameters & functionality (generic test vehicle)	77	0
Mechanical St	ress (Note 2)			
Temperature Cycle	-65°C/150°C 1000 Cycles Method 1010	DC Parameters (generic test vehicle)	77	0

Note 1: Life Test Data may represent plastic D.I.P. qualification lots for the Micro Max package.

Note 2: Generic package/process data

Attachment #3

	Terminal A (Each pin individually connected to terminal A with the other floating)	Terminal B (The common combination of all like-named pins connected to terminal B)
1.	All pins except V _{PS1} <u>3/</u>	All V_{PS1} pins
2.	All input and output pins	All other input-output pins

TABLE II. Pin combination to be tested. 1/2/

- <u>1/</u> Table II is restated in narrative form in 3.4 below.
- $\overline{2/}$ No connects are not to be tested.
- $\overline{3/}$ Repeat pin combination I for each named Power supply and for ground

(e.g., where V_{PS1} is V_{DD} , V_{CC} , V_{SS} , V_{BB} , GND, $+V_{S}$, $-V_{S}$, V_{REF} , etc).

- 3.4 <u>Pin combinations to be tested.</u>
 - a. Each pin individually connected to terminal A with respect to the device ground pin(s) connected to terminal B. All pins except the one being tested and the ground pin(s) shall be open.
 - b. Each pin individually connected to terminal A with respect to each different set of a combination of all named power supply pins (e.g., V_{SS1}, or V_{SS2} or V_{SS3} or V_{CC1}, or V_{CC2}) connected to terminal B. All pins except the one being tested and the power supply pin or set of pins shall be open.

c. Each input and each output individually connected to terminal A with respect to a combination of all the other input and output pins connected to terminal B. All pins except the input or output pin being tested and the combination of all the other input and output pins shall be open.







DOCUMENT I.D. 06-5707	REVISION A	MAXIM TITLE: BI Circuit (MAX 1864/1865)	PAGE 2 OF 3
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